# ±2G/±4G/±8G/±16G 3-AXIS MEMS DIGITAL OUTPUT ACCELEROMETER SENSOR

DESCRIPTION

The SC7A20 is an acceleration sensor IC, which features abundant functions, low power dissipation, small size, and precision measurement.

It communicates with MCU through I²C/SPI interface, the acceleration measurement data can be accessed in interrupt mode or inquiry mode. INT1 and INT2 provide many auto-detected interrupt signals which are suitable to many motion detection fields, interrupt source include 6D/4D direction detection interrupt signal, free fall detection interrupt signal, sleep and wake up detection interrupt signal, and single/double click detection interrupt signal. A high-precision calibration module is available within the IC to accurately compensate the senor's offset error and gain error. It has dynamically user selectable full scales of $\pm$ 2G/$\pm$4G/$\pm$8G/$\pm$16G and it is capable of measuring accelerations with output data rates from 1Hz to 400Hz.

A self-test capability allows the user to check the functioning of the sensor in the final application. The available tilt calibration function is able to compensate the tilt caused by SMT or PCB installation, not occupying system resource, system update will not affect sensor parameters.
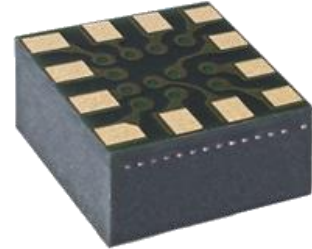
LGA-12-2x2x1.0

APPLICATIONS

- Mobile phones/tablets
- Indoor navigation
- Image rotation
- Motion activated user interfaces
- Gaming

FEATURES

- Wide supply voltage, 1.71V to 3.6V
- Independent IOs supply (1.8V) and supply voltage compatible
- Low power mode consumption down to 2µA
- $\pm$2G/$\pm$4G/$\pm$8G/$\pm$16G dynamically selectable full-scale
- 12-bit effective data (HR)
- I²C/SPI digital output interface
- 6D/4D orientation detection
- Free-fall detection
- Single/double click detection and motion detection
- Programmable interrupt generator
- Embedded self test
- Embedded FIFO
- 10000g high shock survivability

ORDERING INFORMATION

Part No.	Package	Hazardous Substance Control	Packing
SC7A20TR	LGA-12-2x2x1.0	Halogen free	Tape & Reel

BLOCK DIAGRAM
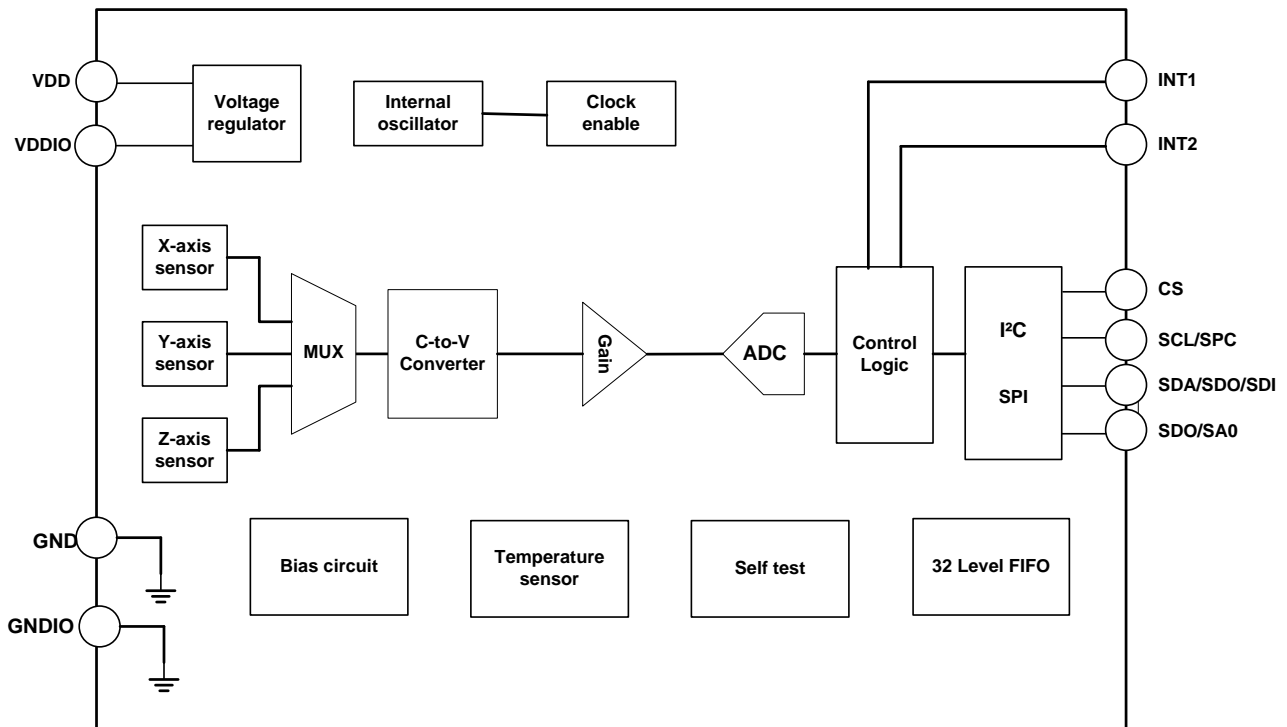
ABSOLUTE MAXIMUM RATING

Characteristics	Symbol	Test conditions	Min.	Max.	Unit
Power supply voltage 1	V_{CC}	Circuit not damaged	-0.3	3.6	V
Power supply voltage 2	V_P	Circuit not damaged	-0.3	3.6	V
Arbitrary control pin	V_{in}	Circuit not damaged	-0.3	$V_{DDIO}+0.3$	V
Operating temperature	T_{OPR}	Circuit not damaged	-40	+85	°C
Storage temperature	T_{STG}	Circuit not damaged	-55	+150	°C

MECHANICAL CHARACTERISTICS (V_{DD}=2.5V, T_A=25°C)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Measurement range	F_{S0}	FS=0	--	±2.0	--	g
	F_{S1}	FS=1	--	±4.0	--	
	F_{S2}	FS=2	--	±8.0	--	
	F_{S3}	FS=3	--	±16.0	--	

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Sensitivity	So0	FS=0 (HR mode)	--	1	--	mg/digit
	So1	FS=1 (HR mode)	--	2	--	
	So2	FS=2 (HR mode)	--	4	--	
	So3	FS=3 (HR mode)	--	8	--	
Sensitivity change vs temperature	T_{CSO}	FS=0	--	±0.01	--	%/°C
Typical zero-g level offset accuracy	Ty_{Off0}	FS=0	--	±80	±200	mg
Zero-g level change vs temperature [Note 1]	TC_{Off}	Max delta from 25°C	--	±0.5	--	mg/°C
Self test output change	V_{st1}	FS=0, X axis	--	276	--	LSb
	V_{st2}	FS=0, Y axis	--	276	--	LSb
	V_{st3}	FS=0, Z axis	--	984	--	LSb
System bandwidth	BW	--	--	ODR/2	--	HZ
Operating temperature range	T_{OPR}	--	-40	--	+85	°C

Note: The product is calibrated at 2.5V by factory. The actual operating voltage ranges from 1.71V to 3.6V.

Note1：In full range, Max. temeprature drift zero drift +zero drift value 60*0.5+200mg=230mg.

ELECTRICAL CHARACTERISTICS (V_{DD}=2.5V,T_A=25°C)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
Supply voltage	V_{DD}	--	1.71	2.5	3.6	V
IO supply voltage	V_{DDIO}	--	1.71	--	V_{DD}+0.1	V
Supply current	I_{DD}	T_A=25°C, ODR=100HZ	--	20	--	μA
Current consumption in low-power mode	I_{DDLP}	T_A=25°C, ODR=100HZ	--	10	--	μA
Current consumption in power-down mode	I_{DDPdn}	T_A=25°C	--	0.5	--	μA
Digital high level input voltage	V_{IH}	--	0.8* V_{DDIO}	--	--	V
Digital low level input voltage	V_{IL}	--	--	--	0.2* V_{DDIO}	V
High level output voltage	V_{OH}	--	0.9* V_{DDIO}	--	--	V
Low level output voltage	V_{OL}	--	--	--	0.1* V_{DDIO}	V
Output data rate	ODR0	ODR= 1Hz	--	1	--	HZ
	ODR1	ODR= 10Hz	--	10	--	
	ODR2	ODR= 25Hz	--	25	--	

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
	ODR3	ODR= 50Hz	--	50	--	
	ODR4	ODR= 100Hz	--	100	--	
	ODR5	ODR= 200Hz	--	200	--	
	ODR6	ODR= 400Hz	--	400	--	
Turn-on time	T_{on}	ODR=100Hz	--	1	--	ms
Operating temperature range	T_{opr}	--	-40	--	+85	°C

I²C CONTROL INTERFACE CHARACTERISTICS (V_{DD}=2.5V, T_A=25°C)

| Characteristics	Symbol	I²C standard mode		I²C fast mode		Unit
		MIN.	MAX.	MIN.	MAX.	
SCL clock frequency	$f_{(SCL)}$	0	100	0	400	KHz
SCL clock low time	$t_{w(SCLL)}$	4.7	--	1.3	--	μs
SCL clock high time	$t_{w(SCLH)}$	4.0	--	0.6	--	
SDA setup time	$t_{su(SDA)}$	250	--	100	--	ns
SDA data hold time	$t_{h(SDA)}$	0.01	3.45	0.01	0.9	μs
SDA/SCL rise time	$t_{r(SDA)}$ $t_{r(SCL)}$	--	1000	20+0.1Cb	300	ns
SDA/SCL fall time	$t_{f(SDA)}$ $t_{f(SCL)}$	--	300	20+0.1Cb	300	ns
START condition hold time	$t_{h(ST)}$	4	--	0.6	--	μs
Repeated STARTcondition setup time	$t_{su(SR)}$	4.7	--	0.6	--	
STOP condition setup time	$t_{su(SP)}$	4	--	0.6	--	
Bus free time between STOP and START conditions	$t_{w(SP:SR)}$	4.7	--	1.3	--	
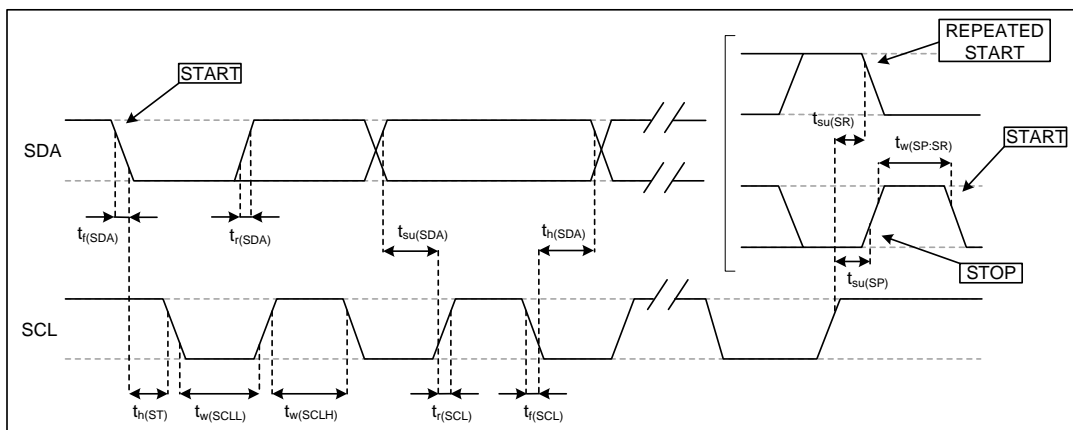
I²C slave timing diagram

## SPI SERIAL PERIPHERALINTERFACE CHARACTERISTICS (V_{DD}=2.5V, T_A=25°C)

Characteristics	Symbol	Test conditions	Min.	Typ.	Max.	Unit
SPI clock cycle[note]	$T_{c(SPC)}$	--	100	--	--	ns
SPI clock frequency	$F_{c(SPC)}$	--	--	--	10	MHz
CS setup time	$T_{su(CS)}$	--	5	--	--	ns
CS hold time	$T_{h(CS)}$	--	8	--	--	
SDI input setup time	$T_{su(SI)}$	--	5	--	--	
SDI input hold time	$T_{h(SI)}$	--	15	--	--	
SDO valid output time	$T_{v(SO)}$	--	--	--	50	
SDO output hold time	$T_{h(SO)}$	--	6	--	--	
SDO output disable time	$T_{dis(SO)}$	--	--	--	50	

Note: 10MHz clock frequency.
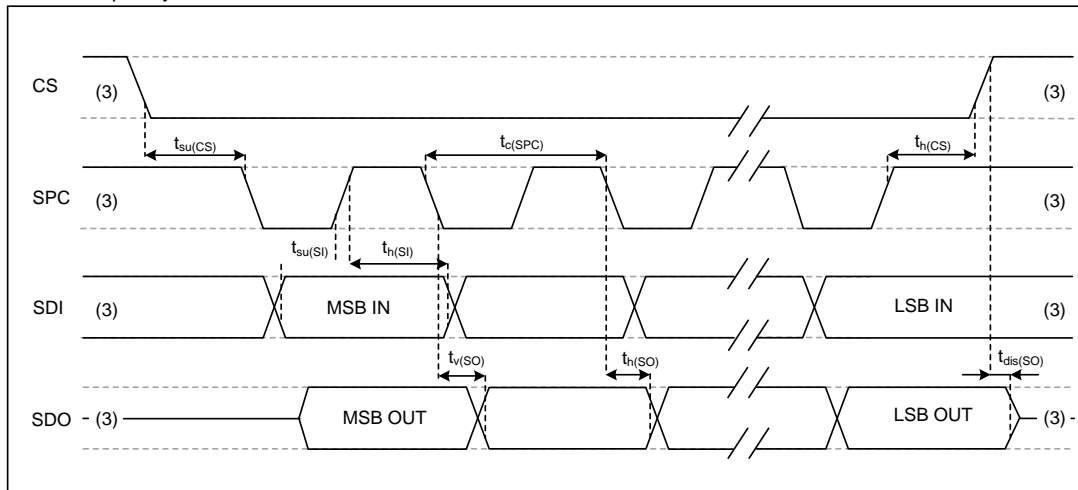
SPI slave timing diagram

PIN CONFIGURATION

(Bottom view)

(Top view)
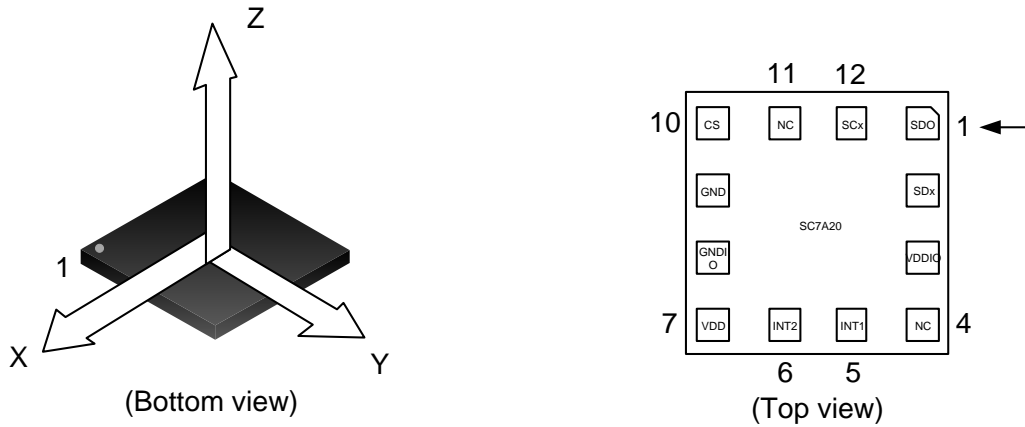
PIN DESCRIPTION

Pin No.	Symbol	I/O	Description	Connection mode		
				I²C mode	SPI four-wire mode	SPI three-wire mode
1	SDO	O	SPI serial data output, address selection in I²C mode	NC for default addr.	SDO	NC
2	SDx	I/O	Used as SDA in I²C mode, Used as SDI in SPI 4-wire mode, Used as SDA in SPI 3-wire mode	SDA	SDI	SDA
3	VDDIO	P	Power supply for I/O pins	VDDIO	VDDIO	VDDIO
4	NC	--	--	GND	GND	GND
5	INT1	O	Interrupt pin 1	INT1	INT1	INT1
6	INT2	O	Interrupt pin 2	INT2	INT2	INT2
7	VDD	P	Power supply	VDD	VDD	VDD
8	GNDIO	Ground	0V supply	GND	GND	GND
9	GND	Ground	0V supply	GND	GND	GND
10	CS	I	I²C/SPI mode selection(1:I²C mode, 0: SPI mode)	NC	CS	CS
11	NC	--	--	NC	NC	NC
12	SCx	I	I²C serial clock (SCL) SPI serial port clock (SCK)	SCL	SCK	SCK

Note: I=input, O=output, OC=collector open-circuit output, P=passive external component, S=power supply.

FUNCTION DESCRIPTION

1   Detailed description

The SC7A20 is an ultra compact low-power, digital output 3-axis linear accelerometer packaged in LGA. The complete device includes a mechanical sensing unit and an integrated circuit interface able to take the information from the sensing unit and to provide a signal to the external MCU through I^{2}C or SPI interface.

2   Mechanical sensing unit

The mechanical sensing unit consists of suspended mass and silicon frame. The suspended mass are attached to the silicon frame in a few points called anchors and are free to move in the direction of the sensed acceleration. To be compatible with the traditional packaging techniques a cap is placed on top of the sensing element to avoid blocking the moving parts during the moulding phase of the plastic encapsulation. When an acceleration is applied to the sensor the proof mass displaces from its nominal position, causing an imbalance in the capacitive half-bridge. This imbalance is measured using charge integration in response to a voltage pulse applied to the capacitor.

At steady state the nominal value of the capacitors are few pF and when an acceleration is applied the maximum variation of the capacitive load is in fF range.

3   IC interface

The complete measurement chain is composed by a low-noise capacitive amplifier which converts the capacitive unbalancing of the MEMS sensor into an analog voltage that is finally available to the user by analog-to-digital converters. The acceleration data may be accessed through an I²C/SPI interface thus making the device particularly suitable for direct interfacing with a microcontroller. The SC7A20 features a data-ready signal (RDY) which indicates when a new set of measured acceleration data is available thus simplifying data synchronization in the digital system that uses the device. It may also be configured to generate an inertial Wake-Up and Free-Fall interrupt signal accordingly to a programmed acceleration event along the enabled axes.

4   Factory calibration

The IC interface is factory calibrated for sensitivity (So) and Zero-g level (Ty$_{Off}$).

The trimming values are stored inside the device in EEPROM. Any time the device is turned on, the trimming parameters are downloaded into the registers to be used during the normal operation. This allows to use the device without further calibration.

5   6D/4D detection

In this configuration the interrupt is generated when the device is stable in a known direction. 6-direction detections in a three-dimensional space are all enabled. Please refer to application note for detailed setting.

6   Free-fall detection

The interrupt is generated when the sensor is in free-fall state. In free-fall state, the sensor mass block is weightlessness, and theoretical three-axis output is zero, the sensor detector detects that the three-axis output is

lower than threshold value, then the interrupt signal is generated, and corresponding state register is set.

7   Sleep and Wake up detection

Sleep detection: when the sensor output keeps constant within given threshold range for a certain time, the sensor is judged as no action, corresponding state signal is set and interrupt signal is generated, the system enters low power mode. Refer to application note for details.

Wake up detection; when the sensor output becomes higher than the threshold value and lasts for a certain time, the sensor is judged as being action, corresponding state signal is set and interrupt signal is generated, the system restores normal operating mode. Refer to application note for details.

8   Single click and double click detection

The sensor judges whether the output reaches conditions for single/double click according to given threshold value and time, sets corresponding state signal and generates interrupt signal. Refer to application note for details.

9   Terminology

9.1   Sensitivity

Sensitivity describes the gain of the sensor and can be determined e.g. by applying 1g acceleration to it. As the sensor can measure DC accelerations this can be done easily by pointing the axis of interest towards the center of the earth, noting the output value, rotating the sensor by 180 degrees (pointing to the sky) and noting the output value again. By doing so, ±1g acceleration is applied to the sensor. Subtracting the larger output value from the smaller one and dividing the result by 2, leads to the actual sensitivity of the sensor. This value changes very little over temperature and also time. The Sensitivity tolerance describes the range of sensitivities of a large population of sensors.

9.2   Zero-g level

Zero-g level Offset (Ty_{Off}) describes the deviation of an actual output signal from the ideal output signal if no acceleration is present. A sensor in a steady state on a horizontal surface measure 0g in X axis and 0g in Y axis whereas the Z axis measure 1g. The output is ideally in the middle of the dynamic range of the sensor (content of OUT registers 00h, data expressed as 2's complement number). A deviation from ideal value in this case is called Zero-g offset. Offset is to some extent a result of stress to MEMS sensor and therefore the offset can slightly change after mounting the sensor onto a printed circuit board or exposing it to extensive mechanical stress. Offset changes little over temperature, "Zero-g offset" is called "temperature offset".

9.3   Self test

Self Test allows to check the sensor functionality without moving it. The Self Test function is off when the self-test bit is programmed to '0'. When the self-test bit is programmed to '1' an actuation force is applied to the sensor, simulating a definite input acceleration. In this case the sensor outputs exhibit a change in their DC levels which are related to the selected full scale through the device sensitivity. When self test is activated, the device output level is given by the algebraic sum of the signals produced by the acceleration acting on the sensor and by the electrostatic test-force. If the output signals change within the amplitude specified inside the range, then the sensor is working properly.

10　Digital interfaces

The registers embedded inside the SC7A20 may be accessed through both the I^{2}C and SPI serial interfaces. The latter may be SW configured to operate either in 3-wire or 4-wire interface mode. The SPI 3-wire mode can be obtained through writing data into corresponding control bit in 4-wire write mode (only three wires needed for writing). These interfaces are multiplexed with communication pins. To use I^{2}C interface, CS signal must be tied high (i.e connected to V$_{DDIO}$).

Communication interface pin description

Pin name	Pin description
CS	SPI enable I^{2}C/SPI mode selection (1: I^{2}C mode; 0: SPI enabled)
SCL/SPC	I^{2}C serial clock (SCL) SPI serial port clock (SPC)
SDA/SDI/SDO	I^{2}C serial data (SDA) SPI serial data input (SDI) 3-wire interface serial data output (SDO)
SDO	SPI serial data output (SDO)

10.1　I^{2}C serial interface

The SC7A20 I^{2}C is a bus slave. The I^{2}C is employed to write data into registers whose content can also be read back. The relevant IIC terminology is given in the table below.

Serial interface pin description

Term	Description
Transmitter	The device which sends data to the bus
Receiver	The device which receives data from the bus
Master	The device which initiates a transfer, generates clock signals and terminates a transfer
Slave	The device addressed by the master

There are two signals associated with the I^{2}C bus: the serial clock line and the serial Data line. The latter is a bidirectional line used for sending and receiving the data to/from the interface. Both the lines are connected to V$_{DDIO}$ through a pull-up resistor embedded inside the SC7A20. When the bus is free both the lines are high. The I^{2}C interface is compliant with fast mode (400 KHz) I^{2}C standards as well as with the normal mode.

10.1.1　I^{2}C operation

The transaction on the bus is started through a START (ST) signal. A START condition is defined as a HIGH to LOW transition on the data line while the SCL line is held HIGH. After this has been transmitted by the master, the bus is considered busy. The next byte of data transmitted after the start condition contains the address of the slave in the first 7 bits and the eighth bit tells whether the Master is receiving data from the slave or transmitting data to the slave. When an address is sent, each device in the system compares the first seven bits after a start condition with its address. If they match, ACK (low level at the 9th CLK) is sent back to the master.

The Slave address (SAD) associated to the SC7A20 is 0011xxxb. Data transfer with ACK signal is mandatory. The transmitter must release the SDA line in the 9th CLK. The receiver must then pull the data line LOW to complete one ACK return. A receiver which has been addressed is obliged to generate an acknowledge after each byte of data has been received. The I2C embedded inside the SC7A20 behaves like a slave device and adheres to similar standard IIC protocol. After the start condition (ST) a slave address is sent, once a slave acknowledge (SAK) has been returned, an 8-bit sub-address is transmitted: the 7 LSb represent the actual register address while the MSB enables address auto increment. If the MSb of the SUB field is 1, the SUB (register address) is automatically incremented to allow multiple data read/write.

The slave address is completed with a Read/Write bit. If the bit is '1' (Read), a repeated START (SR) condition is issued after the two sub-address bytes; if the bit is '0' (Write) the Master will transmit to the slave with direction unchanged.

I2C address

SDO external connection	7-bit I2C address	8-bit I2C address	Remark
Floating/logic high	0x19	0x32(W)、0x33(R)	Non leakage current
Logic low	0x18	0x30(W)、0x31(R)	Turn off internal pull-up resistor

Transfer when master is writing one byte to slave

Master	ST	SAD+W		SUB		DATA		SP
Slave			SAK		SAK		SAK	

Transfer when master is writing multiple bytes to slave

Master	ST	SAD+W		SUB		DATA		DATA		SP
Slave			SAK		SAK		SAK		SAK	

Transfer when master is receiving (reading) one byte of data from slave

| Master	ST	SAD+W		SUB		SR	SAD+R			MAK		MAK		NMAK	SP
Slave			SAK		SAK				SAK	DATA		DATA		DATA		

Data are transmitted in byte format (DATA). Each data transfer contains 8 bits. The number of bytes transferred per transfer is unlimited. Data is transferred with the Most Significant bit (MSb) first. If a receiver can't receive another complete byte of data until it has performed some other function, it can hold the clock line, SCL LOW to force the transmitter into a wait state. Data transfer only continues when the receiver is ready for another byte and releases the data line. If a slave receiver doesn't acknowledge the slave address (i.e. it is not able to receive because it is performing some real time function) the data line must be left HIGH by the slave. The Master can then abort the transfer. A LOW to HIGH transition on the SDA line while the SCL line is HIGH is defined as a STOP condition. Each data transfer must be terminated by the generation of a STOP (SP) condition.

In order to read multiple bytes, it is necessary to assert the most significant bit of the subaddress field. In other words, SUB(7) must be equal to 1 while SUB(6-0) represents the address of first register to be read.

For example, after the sensor is configured to work, continuous reading of triaxial data (register address 0x28 ~ 0x2d) is adopted, and the address of register data is 0xA8 (0x28 | 0x80).

10.2 SPI bus interface

The SC7A20 SPI is a bus slave. The SPI allows to write and read the registers of the device. The serial interface interacts with the outside world with 4 wires: CS, SPC, SDI, and SDO.
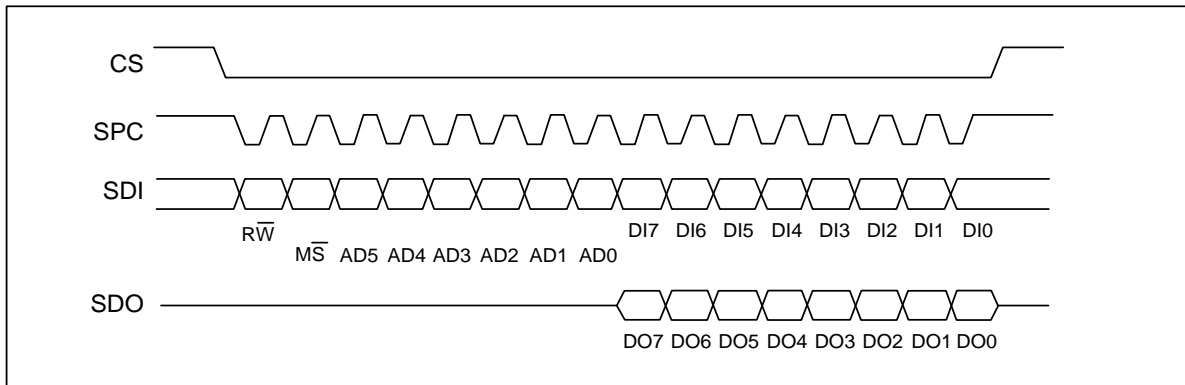

SPI read and write protocol

CS is the Serial Port Enable and it is controlled by the SPI master. It goes low at the start of the transmission and goes back high at the end. SPC is the Serial Port Clock and it is controlled by the SPI master. It is stopped high when CS is high (no transmission). SDI and SDO are respectively the Serial Port Data Input and Output. Those lines are driven at the falling edge of SPC and should be captured at the rising edge of SPC. Both the read register and write register commands are completed in 16 clock pulses or in multiple of 8 in case of multiple bytes read/write. The first bit (bit 0) starts at the first falling edge of SPC after the falling edge of CS while the last bit (bit 15, bit 23, ...) starts at the last falling edge of SPC just before the rising edge of CS.

➢ Bit0: $R\overline{W}$ bit. When 0, the data DI(7:0) is written into the device. When 1, the data DO(7:0) is read from the device. In latter case, the chip will drive SDO at the start of bit 8.

➢ Bit1: $M\overline{S}$ bit. When 0, the address remains unchanged. When 1, the address is auto incremented in multiple read/write commands.

➢ Bit2-7: address AD(5:0), the register address.

➢ Bit8-15: data DI(7:0) (write mode), the data that is written into the slave device (MSB first).

➢ Bit8-15: data DO(7:0) (read mode), the data that is read from the slave device (MSB first).

In multiple read/write commands further blocks of 8 clock periods are added. When $M\overline{S}$ bit is 0, the address used to read/write data remains the same for every block. When $M\overline{S}$ bit is 1 the address used to read/write data is incremented at every block. The function and behavior of SDI and SIO remain unchanged.

10.2.1 SPI read
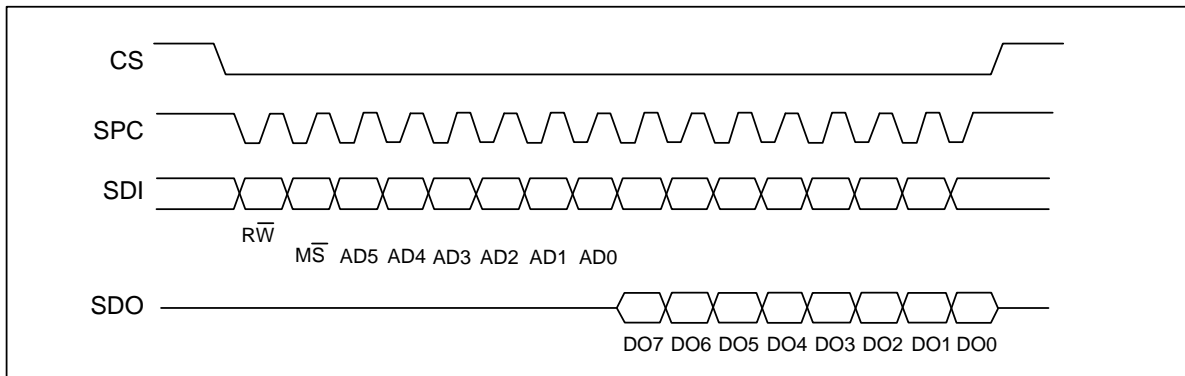
SPI read protocol

The SPI read command is performed with 16 clock pulses. Multiple byte read command is performed adding blocks of 8 clock pulses at the pervious one.

➢   Bit0: read bit. The value is 1.

➢   Bit1: M$\overline{S}$ bit. When 0, do not increment address, when 1, increment address for multiple writing.

➢   Bit2-7: address AD(5:0), the register address.

➢   Bit8-15: data DO(7:0) (read mode), the data that is read from the slave device (MSB first).

➢   Bit16-…: data DO(…:8) (read mode), further data in multiple byte reading (MSB first).

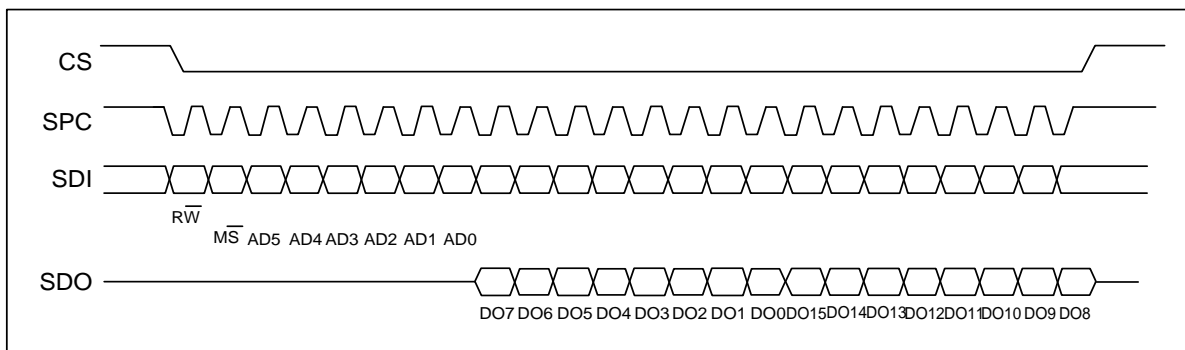Multiple bytes SPI read protocol (2 bytes example)
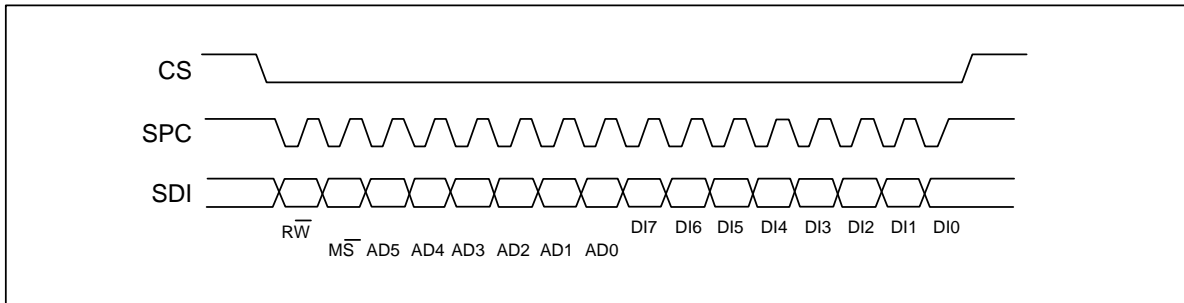
10.2.2 SPI write

SPI write protocol

The SPI write command is performed with 16 clock pulses. Multiple byte write command is performed adding blocks of 8 clock pulses at the pervious one.

➢ Bit0: WRITE bit, the value is 0.

➢ Bit1: M$\overline{S}$ bit. When 0, do not increment address, when 1, increment address for multiple writing.

➢ Bit2-7: address AD(5:0), the register address.

➢ Bit8-15: data DI(7:0) (write mode), the data that is written inside the slave device (MSB first).

➢ Bit16-…: data DI(…:8) (write mode), further data in multiple byte writing (MSB first).
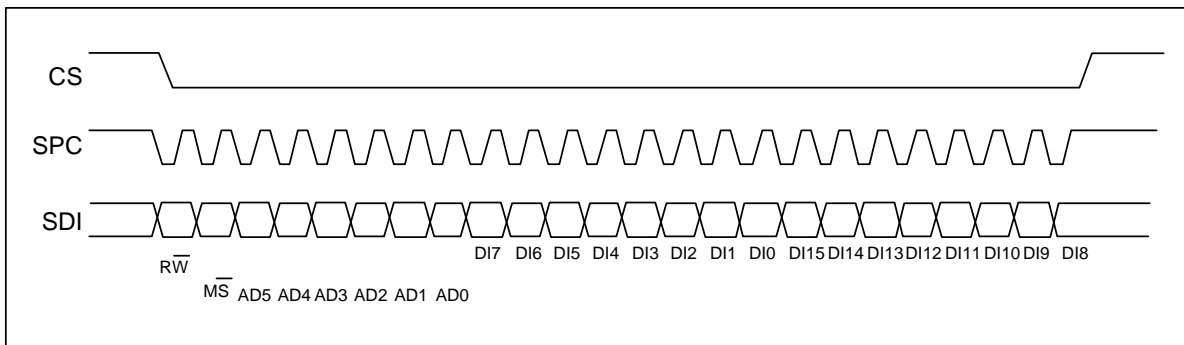
Multiple bytes SPI write protocol (2 bytes as an example)

10.2.3 SPI read in 3-wire mode

3-wire mode is entered by writing 1 to SIM bit. Only three signals lines are used in both 4-wire mode and 3-wire mode, and the logic and timing are both the same in these two modes, hence, it is able to configure the slave as 3-wire mode through 4-wire write mode.

SPI read protocol in 3-wire mode

The SPI read command is performed with 16 clock pulses.

➢ Bit0: read bit, the value is 1.

➢ Bit1: M$\overline{S}$ bit. When 0, do not increment address, when 1, increment address for multiple reading.

➢ Bit2-7: address AD(5:0), the register address.

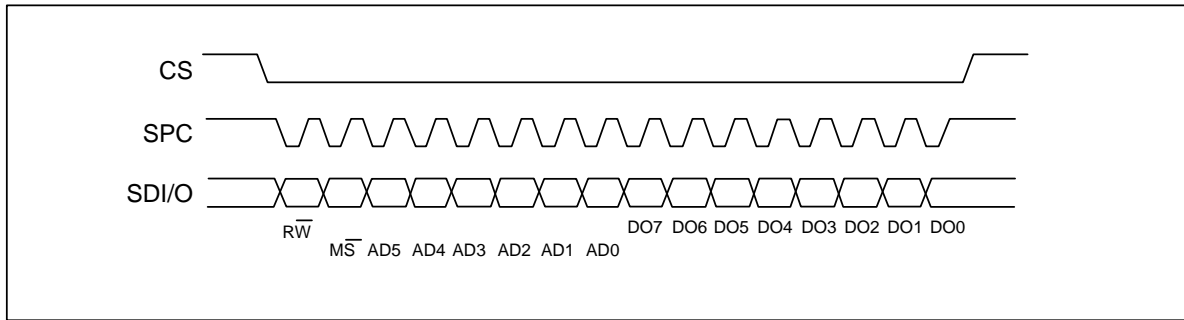➢ Bit8-15: data DO(7:0) (read mode), the data that is read from the slave device (MSB first).

When SPI mode is used to read three-axis FIFO data continuously, it needs to read from the register of 0x27, read 7 bytes of data continuously, and take the last 6 bytes to splice into three-axis data. Special attention: multiple SPI devices are forbidden to reuse SPC, MOSI and MISO.

11 Register mapping

The table given below lists all registers in SC7A20 and their addresses and initial values.

Name	Type	Register address		Default	Comment
		Hex	Binary		
Reserved (do not modify)	--	00-0B	--	--	Reserved
OUT_TEMP_L	r	0C	0001100	output	--
OUT_TEMP_H	r	0D	0001101	output	--
Reserved (do not modify)	--	0E	--	--	Reserved
WHO_AM_I	r	0F	000 1111	00010001	--
Reserved (do not modify)	--	10-12	--	--	Reserved
USER_CAL	--	13-1A	--	--	--
Reserved (do not modify)	--	1B-1D	--	--	Reserved
NVM_WR	rw	1E	001 1110	00000000	--
TEMP_CFG	rw	1F	001 1111	output	--
CTRL_REG1	rw	20	010 0000	00000111	--
CTRL_REG2	rw	21	010 0001	00000000	--
CTRL_REG3	rw	22	010 0010	00000000	--
CTRL_REG4	rw	23	010 0011	00000000	--
CTRL_REG5	rw	24	010 0100	00000000	--
CTRL_REG6	rw	25	010 0101	00000000	--
REFERENCE	rw	26	010 0110	00000000	--

Name	Type	Register address Hex	Binary	Default	Comment
STATUS_REG	rw	27	010 0111	00000000	--
OUT_X_L	r	28	010 1000	output	--
OUT_X_H	r	29	010 1001	output	--
OUT_Y_L	r	2A	010 1010	output	--
OUT_Y_H	r	2B	010 1011	output	--
OUT_Z_L	r	2C	010 1100	output	--
OUT_Z_H	r	2D	010 1101	output	--
FIFO_CTRL_REG	rw	2E	010 1110	00000000	--
FIFO_SRC_REG	r	2F	010 1111	--	--
INT1_CFG	rw	30	011 0000	00000000	--
INT1_SOURCE	r	31	011 0001	00000000	--
INT1_THS	rw	32	011 0010	00000000	--
INT1_DURATION	rw	33	011 0011	00000000	--
INT2_CFG	rw	34	011 0100	00000000	--
INT2_SOURCE	r	35	011 0101	00000000	--
INT2_THS	rw	36	011 0110	00000000	--
INT2_DURATION	rw	37	011 0111	00000000	--
CLICK_CFG	rw	38	011 1000	00000000	--
CLICK_SRC	r	39	011 1001	00000000	--
CLICK_THS	rw	3A	011 1010	00000000	--
TIME_LIMIT	rw	3B	011 1011	00000000	--
TIME_LATENCY	rw	3C	011 1100	00000000	--
TIME_WINDOW	rw	3D	011 1101	00000000	--
ACT_THS	rw	3E	011 1110	--	--
ACT_DURATION	rw	3F	011 1111	--	--

Registers marked as *Reserved* must not be changed. The writing to those registers may cause permanent damages to the device.

The content of the registers that are loaded at boot should not be changed. They contain the factory calibration values. Their content is automatically restored when the device is powered-up.

12 Rrgister description

12.1 Control register 1(20h)

B7	B6	B5	B4	B3	B2	B1	B0
ODR3	ODR2	ODR1	ODR0	LPen	Zen	Yen	Xen

ODR3-0	Data rate selection, default value: 0000
LPen	Low power dissipation enable, default value: 0.

	(0: normal mode; 1: low power dissipation mode)
Zen	Z-axis enable, default value:1.
	(0: Z-axis disable, 1: Z-axis enable)
Yen	Y-axis enable, default value:1.
	(0: Y-axis disable, 1: Y-axis enable)
Xen	X-axis enable, default value:1.
	(0: X-axis disable, 1: X-axis enable)

ODR<3:0> is adopted for power supply mode and data rate selection. The frequency setting through ODR<3:0> is shown as below.

Data output rate setting:

ODR3	ODR2	ODR1	ODR0	Power supply mode selection
0	0	0	0	Power supply off mode
0	0	0	1	Normal l / low power passition mode (1 Hz)
0	0	1	0	Normal l / low power passition mode (10 Hz)
0	0	1	1	Normal l / low power passition mode (25 Hz)
0	1	0	0	Normal l / low power passition mode (50 Hz)
0	1	0	1	Normal l / low power passition mode (100 Hz)
0	1	1	0	Normal l / low power passition mode (200 Hz)
0	1	1	1	Normal l / low power passition mode (400 Hz)
1	0	0	0	low power passition mode (1.6 KHz)
1	0	0	1	Normal mode (1.25 kHz) / low power passition mode (5 KHz)

12.2 Control register 2 (21h)

B7	B6	B5	B4	B3	B2	B1	B0
HPM1	HPM0	HPCF2	HPCF1	FDS	HPCLICK	HPIS2	HPIS1

HPM1-HPM0	High pass mode. Default value: 00
	refer to "high pass mode configuration"
HPCF2 -HPCF1	High pass cutoff frequency selection
FDS	Data filtering selection. Default value: 0
	(0: skip internal filtering; 1: data is output to data register or FIFO after filtering
HPCLICK	CLICK High pass filtering enable
	(0: filtering disable; 1: filtering enable)
HPIS2	Interrupt 2 AOI high pass filtering enable
	(0: filtering disable; 1: filtering enable)
HPIS1	Interrupt 1 AOI high pass filtering enable
	(0: filtering disable; 1: filtering enable)

High pass mode configuration

HPM1	HPM0	High pass filtering mode
0	0	Normal mode (read high pass filtering is reset automatically
0	1	Filtering reference signal
1	0	Normal mode
1	1	Interrupt event automatic reset

12.3 Control register 3(22h)

B7	B6	B5	B4	B3	B2	B1	B0
I1_CLICK	I1_AOI1	I1_AOI2	I1_DRDY1	I1_DRDY2	HI1_WTM	I1_OVERRUN	--

I1_CLICK	CLICK interrupt on INT1. Default value:0 (0: disable; 1: enable)
I1_AOI1	AOI1 interrupt on INT1. Default value:0 (0: disable; 1: enable)
I1_AOI2	AOI2 interrupt on INT1. Default value:0 (0: disable; 1: enable)
I1_DRDY1	DRDY1 interrupt on INT1. Default value:0 (0: disable; 1: enable)
I1_DRDY2	DRDY2 interrupt on INT1. Default value:0 (0: disable; 1: enable)
I1_WTM	FIFO interrupt on INT1. Default value:0 (0: disable; 1: enable)
I1_OVERRUN	FIFO interrupt on INT1. Default value:0 (0: disable; 1: enable)

12.4 Control register 4(23h)

B7	B6	B5	B4	B3	B2	B1	B0
BDU	BLE	FS1	FS0	HR	ST1	ST0	SIM

BDU	Block data update. Default value: 0 (0: continuous update, 1: output is not updated until MSB and LSB are read)
BLE	Big/little-Endians data selection. Default value: 0 (0: low-byte data is in low-byte address; 1: high-byte data is in low-byte address;
FS1-FS0	Full scale selection. Default value: 00 (00: +/- 2G; 01: +/- 4G; 10: +/- 8G; 11: +/- 16G)
HR	High resolution output mode selction. Default value: 0 (0: hgh resolution disable; 1: high resolution enable)
ST1-ST0	Self test enable. Default value: 00 (00: self test diable; others: refer to "self test mode configuration")

SIM	SPI serial interface mode configuration. Default value: 0
	(0: 4-wire interface; 1: 3-wire interface)

Sele test mode configuration

ST1	ST0	Test mode
0	0	Normal mode
0	1	Self test 0
1	0	Self test 1
1	1	--

12.5 Control register5(24h)

B7	B6	B5	B4	B3	B2	B1	B0
BOOT	FIFO_EN	--	--	LIR_INT1	D4D_INT1	LIR_INT2	D4D_INT2

BOOT	Reload trimming value. Default value: 0
	(0: normal mode; 1: reload trimming value)
FIFO_EN	FIFO enable. Default value: 0
	(0: FIFO disable; 1: FIFO enable)
LIR_INT1	Interrupt response specified by lockout interrupt 1 configuration register
	Interrupt lockout singal can be cleared through reading interrupt 1 configuration register. Default value: 0
	(0: interrupt signal is unlocked; 1: interrupt signal is locked)
D4D_INT1	4D enable: 4D detection is enable on pin INT1, 6D of interrupt 1 configuration register is set to 1.
LIR_INT2	Interrupt response specified by lockout interrupt 2 configuration register
	Interrupt lockout singal can be cleared through reading interrupt 2 configuration register. Default value: 0
	(0: interrupt signal is unlocked; 1: interrupt signal is locked)
D4D_INT2	4D enable: 4D detection is enable on pin INT2, 6D of interrupt 2 configuration register is set to 1.

12.6 Control register 6(25h)

B7	B6	B5	B4	B3	B2	B1	B0
I2_CLICK	I2_INT1	I2_INT2	BOOT_I2	0	--	H_LACTIVE	--

I2_CLICK	CLICK interrupt on INT2. Default value: 0
	(0: disable; 1: enable)
I2_INT1	AOI2 interrupt on INT1. Default value: 0
	(0: disable; 1: enable)
I2_INT2	AOI2 interrupt on INT2. Default value: 0
	(0: disable; 1: enable)

BOOT_I2	BOOT interrupt on INT2. Default value: 0
	(0: disable; 1: enable)
H_LACTIVE	0: interrupt triggered by high level; 1: interrupt triggered by low level

12.7 Status register (27h)

B7	B6	B5	B4	B3	B2	B1	B0
ZYXOR	ZOR	YOR	XOR	ZYXDA	ZDA	YDA	XDA

ZYXOR	One or more data of X/Y/Z-axis is covered by new data. Default value: 0
	(0: no data of X/Y/Z-axis is covered by new data;
	1: one or more data of X/Y/Z-axis is covered by new data
ZOR	Data of Z-axis is covered by new data. Default value: 0
	(0: data of Z-axis is not covered by new data
	1: data of Z-axis is covered by new data)
YOR	Data of Y-axis is covered by new data. Default value: 0
	(0: data of Y-axis is not covered by new data
	1: data of Y-axis is covered by new data)
XOR	Data of X-axis is covered by new data. Default value: 0
	(0: data of X-axis is not covered by new data
	1: data of X-axis is covered by new data)
ZYXDA	All data of X/Y/Z-axis are covered by new data. Default value: 0
	(0: One or more data of X/Y/Z-axis is not covered by new data; 1: All data of X/Y/Z-axis are covered by new data.)
ZDA	Z-axis old data is covered by new data. Default value: 0
	(0:Z-axis old data is not covered by new data;
	1: Z-axis old data is covered by new data)
YDA	Y-axis old data is covered by new data. Default value: 0
	(0:Y-axis old data is not covered by new data;
	1: Y-axis old data is covered by new data)
XDA	X-axis old data is covered by new data. Default value: 0
	(0:X-axis old data is not covered by new data;
	1: X-axis old data is covered by new data)

12.8 OUT_X_L(28h), OUT_X_H (29h)

X-axis accelerometer value, data is expressed as 2's complement number.

12.9 OUT_Y_L (2Ah),OUT_Y_H (2Bh)

Y-axis accelerometer value, data is expressed as 2's complement number.

12.10 OUT_Z_L (2Ch),OUT_Z_H (2Dh)

Z-axis accelerometer value, data is expressed as 2's complement number.

12.11 Interrupt 1 configuration (30h)

B7	B6	B5	B4	B3	B2	B1	B0
AOI	6D	ZHIE/ ZUPE	ZLIE/ ZDOWNE	YHIE/ YUPE	YLIE/ YDOWNE	XHIE/ XUPE	XLIE/ XDOWNE

AOI	And/or interrupt. Default value: 0. Refer to "interrupt mode"
6D	6D test enable. Default value: 0. Refer to "interrupt mode"
ZHIE/ ZUPE	Z-axis high interrupt or Z-axis direction test interrupt enable . Default value: 0. (0:Interrupt is disable; 1: interrupt is enable)
ZLIE/ ZDOWNE	Z-axis low interrupt or Z-axis direction test interrupt enable . Default value: 0. (0:Interrupt is disable; 1: interrupt is enable)
YHIE/ YUPE	Y-axis high interrupt or Y-axis direction test interrupt enable . Default value: 0. (0:Interrupt is disable; 1: interrupt is enable)
YLIE/ YDOWNE	Y-axis low interrupt or Y-axis direction test interrupt enable . Default value: 0. (0:Interrupt is disable; 1: interrupt is enable)
XHIE/ XUPE	X-axis high interrupt or X-axis direction test interrupt enable . Default value: 0. (0:Interrupt is disable; 1: interrupt is enable)
XLIE/ XDOWNE	X-axis low interrupt or X-axis direction test interrupt enable . Default value: 0. (0:Interrupt is disable; 1: interrupt is enable)

AOI	6D	Interrupt mode
0	0	Or interrupt event
0	1	6D Motion Recognition
1	0	And interrupt event
1	1	6D position detection

12.12 Interrupt 1 status register (31h)

B7	B6	B5	B4	B3	B2	B1	B0
0	IA	ZH	ZL	YH	YL	XH	XL

IA	Interrupt activation. Default value: 0. (0: no interrupt ; 1: one or more interrupt occurs)
ZH	Z-axis high. Default value: 0. (0: no interrupt ; 1: Z-axis high event occurs)
ZL	Z-axis low. Default value: 0. (0: no interrupt ; 1: Z-axis low event occurs)
YH	Y-axis high. Default value: 0. (0: no interrupt ; 1: Y-axis high event occurs)

YL	Y-axis low. Default value: 0.
	(0: no interrupt ; 1: Y-axis low event occurs)
XH	X-axis high. Default value: 0.
	(0: no interrupt ; 1: X-axis high event occurs)
XL	X-axis low. Default value: 0.
	(0: no interrupt ; 1: X-axis low event occurs)

12.13 Interrutp 1 threshold register (32h)

B7	B6	B5	B4	B3	B2	B1	B0
0	THS6	THS5	THS4	THS3	THS2	THS1	THS0

THS6 - THS0	Interrupt 1 threshold. Default value: 000 0000
	1LSB=16mg @ FS=2g
	1LSB=32mg @ FS=4g
	1LSB=64mg @ FS=8g
	1LSB=128mg @ FS=16g

12.14 Interrupt 1 duration (33h)

B7	B6	B5	B4	B3	B2	B1	B0
0	D6	D5	D4	D3	D2	D1	D0

D6 - D0	Duration count value. Default value: 000 0000

Min. duration of interrupt 1 is recognized through D6 - D0 position recognition.

Max. duration and step is counted with clock of ODR.

12.15 Interrutp 2 configuration (34h)

B7	B6	B5	B4	B3	B2	B1	B0
AOI	6D	ZHIE/ ZUPE	ZLIE/ ZDOWNE	YHIE/ YUPE	YLIE/ YDOWNE	XHIE/ XUPE	XLIE/ XDOWNE

AOI	And/or interrupt. Default value: 0. Refer to "interrupt mode"
6D	6D test enable. Default value: 0. Refer to "interrupt mode"
ZHIE/ ZUPE	Z-axis high interrupt or Z-axis direction test interrupt enable . Default value: 0.
	(0:Interrupt is disable; 1: interrupt is enable)
ZLIE/ ZDOWNE	Z-axis low interrupt or Z-axis direction test interrupt enable . Default value: 0.
	(0:Interrupt is disable; 1: interrupt is enable)
YHIE/ YUPE	Y-axis high interrupt or Y-axis direction test interrupt enable . Default value: 0.
	(0:Interrupt is disable; 1: interrupt is enable)
YLIE/ YDOWNE	Y-axis low interrupt or Y-axis direction test interrupt enable . Default value: 0.
	(0:Interrupt is disable; 1: interrupt is enable)

XHIE/	X-axis high interrupt or X-axis direction test interrupt enable . Default value: 0.
XUPE	(0:Interrupt is disable; 1: interrupt is enable)
XLIE/	X-axis low interrupt or X-axis direction test interrupt enable . Default value: 0.
XDOWNE	(0:Interrupt is disable; 1: interrupt is enable)

AOI	6D	Interrupt mode
0	0	Or interrupt event
0	1	6D Motion Recognition
1	0	And interrupt event
1	1	6D position detection

12.16 Interrupt 2 status register (35h)

B7	B6	B5	B4	B3	B2	B1	B0
0	IA	ZH	ZL	YH	YL	XH	XL

IA	Interrupt activation. Default value: 0.
	(0: no interrupt ; 1: one or more interrupt occurs)
ZH	Z-axis high. Default value: 0.
	(0: no interrupt ; 1: Z-axis high event occurs)
ZL	Z-axis low. Default value: 0.
	(0: no interrupt ; 1: Z-axis low event occurs)
YH	Y-axis high. Default value: 0.
	(0: no interrupt ; 1: Y-axis high event occurs)
YL	Y-axis low. Default value: 0.
	(0: no interrupt ; 1: Y-axis low event occurs)
XH	X-axis high. Default value: 0.
	(0: no interrupt ; 1: X-axis high event occurs)
XL	X-axis low. Default value: 0.
	(0: no interrupt ; 1: X-axis low event occurs)

12.17 Interrutp 2 threshold register (36h)

B7	B6	B5	B4	B3	B2	B1	B0
0	THS6	THS5	THS4	THS3	THS2	THS1	THS0

THS6 - THS0	Interrupt 2 threshold. Default value: 000 0000
	1LSB=16mg @ FS=2g
	1LSB=32mg @ FS=4g
	1LSB=64mg @ FS=8g
	1LSB=128mg @ FS=16g

12.18 Interrupt 2 duration (37h)

B7	B6	B5	B4	B3	B2	B1	B0
0	D6	D5	D4	D3	D2	D1	D0

| D6 - D0	Duration count value. Default value: 000 0000

Min. duration of interrupt 2 is recognized through D6 - D0 position recognition.

Max. duration and step is counted with clock of ODR.

TYPICAL APPLICATION CIRCUIT

IIC
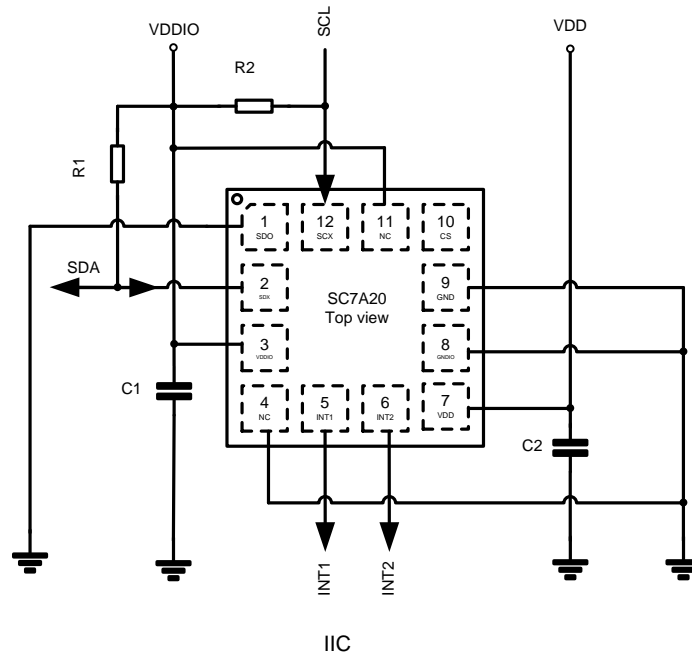
Note: when the SDO (Pin1) pin is grounded, the pull-up resistance leakage will be caused. Suspended or connected to high level is recommended, and internal pull-up function can also be turned off through IIC configuration.


4wire SPI

3wire SPI
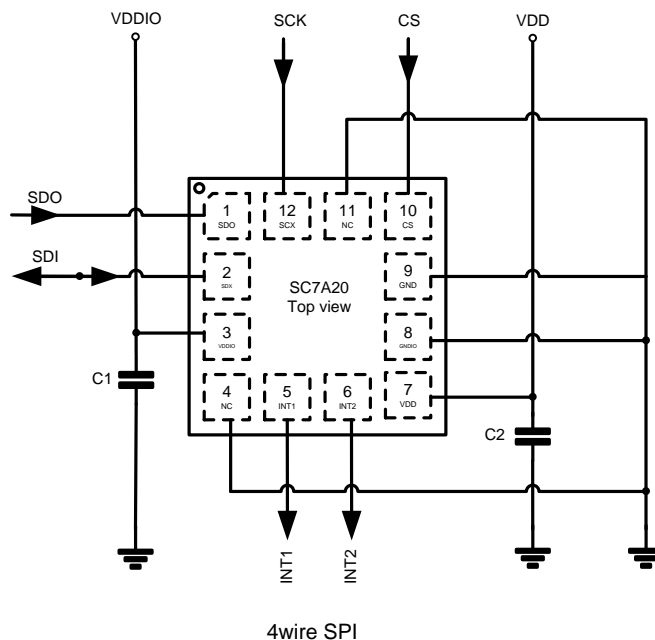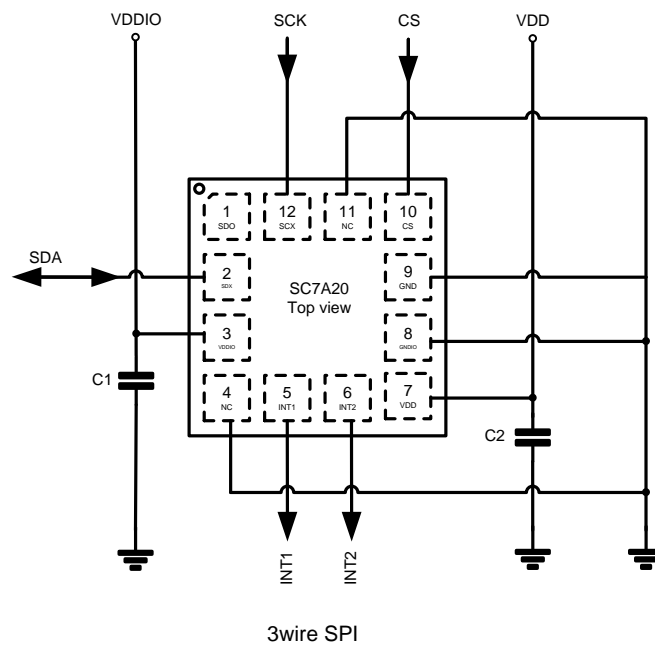
Note: C_1 and C_2 are recommended to be 100nF, while R_1 and R_2 to be 4.7KΩ.

The device core is supplied through V_{DD} while the I/Os are supplied through V_{DD_IO}. All the voltage and ground supplies must be present at the same time to have proper behavior of the IC.

PACKAGE OUTLINE

LGA-12-2x2x1.0	UNIT: mm

LASER MARK
PIN1 I.D.

E

D

TOP VIEW

b

b1

D1

e

E1

BOTTOM VIEW

A

A3

c

0.05

Seating plane
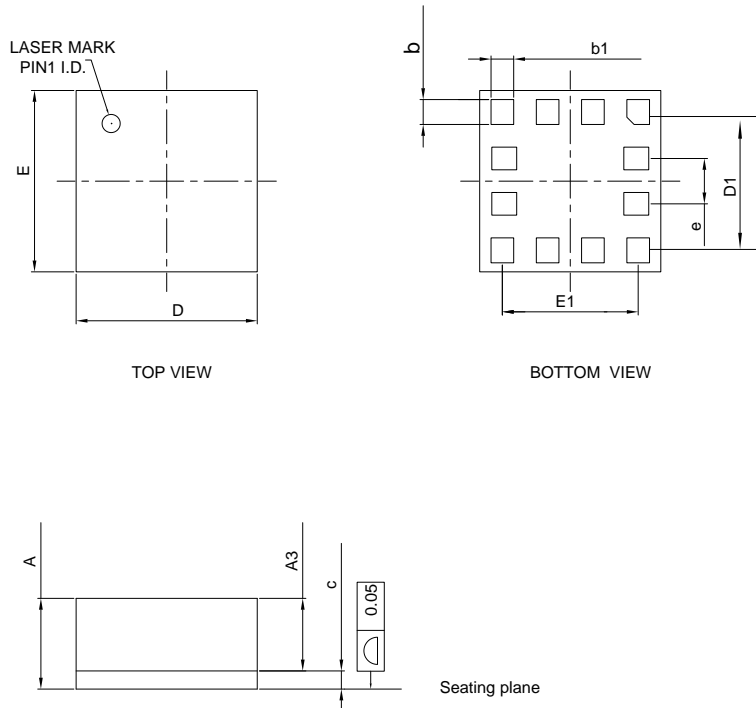
SYMBOL	MILLIMETER		
	MIN	NOM	MAX
A	0.930	—	1.050
A3	0.650	—	0.850
c	0.130	—	0.300
D	1.900	2.000	2.100
E	1.900	2.000	2.100
D1	1.520 BSC		
E1	1.500 BSC		
b	0.220	0.275	0.325
b1	0.200	0.250	0.300
e	0.450	0.500	0.550

CAUTION
ELECTROSTATIC

SENSITIVE DEVICE
DO NOT OPEN OR HANDLE
EXPECT AT A STATIC-FREE
WORKSTATION

MOS DEVICES OPERATE NOTES:

Electrostatic charges may exist in many things. Please take following preventive measures to prevent effectively the MOS electric circuit as a result of the damage which is caused by discharge:

- The operator must put on wrist strap which should be earthed to against electrostatic.
- Equipment cases should be earthed.
- All tools used during assembly, including soldering tools and solder baths, must be earthed.
- MOS devices should be packed in antistatic/conductive containers for transportation.

Important notice :

- The instructions are subject to change without notice！ Customers should obtain the latest relevant information before placing orders and should verify that such information is complete and current.
- Our products are consumer electronic products, and / or civil electronic products.
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Rev.:	1.3

Revision History:

1. Update Max value of Ty_{Off0}

Rev.:	1.2

Revision History:

1. Delete MSL,Orientation of part on carrier tape and UNSCRAMBLE LOT NO.

Rev.:	1.1

Revision History:

1. Modify the seal comment description
2. Add MSL,Orientation of part on carrier tape and UNSCRAMBLE LOT NO.
3. Update Stereogram

Rev.:	1.0

Revision History:

1. First release